



# Product Change Notification

**Change Notification #:** 117473 - 00  
**Change Title:** Hot-swap Backplane Improvement  
 A2U8X25S3PHS, Intel® Server System  
 R2208WF0ZSR, Intel® Server System  
 R2208WFQZSR, Intel® Server System  
 R2208WFTZSR, Intel® Server System  
 R2224WFTZSR, PCN 117473-00, Product Design, Product Material, Capacitor cut out  
**Date of Publication:** March 11, 2020

## Key Characteristics of the Change:

Product Design, Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material: *</b>	March 26, 2020
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is cutting out the capacitor C3N4 from all products listed in below "Product Affected" table. This is to improve the voltage regulation sense feedback loop. As a result of this change the TA number and PBA will roll-up.

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers as a result of this change, but encourages customers to understand the change and determine the impact on their applications. For this reason, Intel recommends that the customer perform a standard level of evaluation.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
A2U8X25S3PHS	955858	J12659-004	H88386-251	J12659-005	H88386-252
R2208WF0ZSR	986050	K39997-006	H88386-251	K39997-007	H88386-252
R2208WFQZSR	986055	K40017-003	H88386-251	K40017-004	H88386-252
R2208WFTZSR	986049	K39991-007	H88386-251	K39991-008	H88386-252
R2224WFTZSR	986051	K39998-006	H88386-251	K39998-007	H88386-252

## PCN Revision History:

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
March 11, 2020	00	Originally Published PCN



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## 117473 - 00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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